| L Number | Hits | Search Text | DB | Time stamp |
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| - | 1261 | 100 | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2003/05/23 12:54 |
| - | 1049 | ((cut\$4 or dic\$3 or separat\$3) near10 ((block\$1 or rib\$1) near5 support\$3)) and (semiconductor\$1 or circuit\$1 or wafer\$1) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/05/23 12:58 |